



NTE5517 thru NTE5519 Silicon Controlled Rectifier (SCR)

Absolute Maximum Ratings:

Repetitive Peak Off-State Voltage ($T_J = +100^\circ\text{C}$), V_{DRM}

NTE5517	200V
NTE5518	400V
NTE5519	600V

Repetitive Peak Reverse Voltage ($T_J = +100^\circ\text{C}$), V_{RRM}

NTE5517	200V
NTE5518	400V
NTE5519	600V

RMS On-State Current ($T_C = +75^\circ\text{C}$), $I_{T(\text{RMS})}$

35A

Peak Surge (Non-Repetitive) On-State Current (One Cycle, 50Hz or 60Hz), I_{TSM}

350A

Peak Gate-Trigger Current (3μs Max), I_{GTM}

20A

Peak Gate-Power Dissipation ($I_{\text{GT}} \leq I_{\text{GTM}}$ for 3μs Max), P_{GM}

20W

Average Gate-Power Dissipation, $P_{\text{G(AV)}}$

0.5W

Operating Temperature Range, T_{opr}

-40° to +150°C

Storage Temperature Range, T_{stg}

-40° to +100°C

Typical Thermal Resistance, Junction-to-Case, R_{thJC}

0.9°C/W

Electrical Characteristics: (At Maximum Ratings and Specified Case Temperatures)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Peak Off-State Current	$I_{\text{DRM}}, I_{\text{RRM}}$	$T_J = +100^\circ\text{C}$, Gate Open, V_{DRM} and V_{RRM} = Max. Rating	-	-	2.0	mA
Maximum On-State Voltage (Peak)	V_{TM}	$T_C = +25^\circ\text{C}$	-	-	1.6	V
Peak On-State Current	I_{TM}		-	-	70	A
DC Holding Current	I_H	$T_C = +25^\circ\text{C}$, Gate Open	-	-	50	mA
DC Gate-Trigger Current	I_{GT}	Anode Voltage = 12V, $R_L = 30\Omega$, $T_C = +25^\circ\text{C}$	-	-	25	mA
DC Gate-Trigger Voltage	V_{GT}	Anode Voltage = 12V, $R_L = 30\Omega$, $T_C = +25^\circ\text{C}$	-	-	2.0	V
Gate Controlled Turn-On Time	t_{gt}	$t_d + t_r$, $I_{\text{GT}} = 150\text{mA}$	-	2.5	-	μs
Critical Rate-of-Rise of Off-State Voltage	Critical dv/dt	$T_C = +100^\circ\text{C}$, Gate Open	-	100	-	V/μs

